



# DUPONT™ 4899R

## SOLDERABLE SILVER TERMINATION

### PRODUCT DESCRIPTION

DuPont™ 4899R is a solderable cadmium-free\* and lead-free\* silver termination for lead attachment to multilayer capacitors. This product has good solderability and high adhesion over a wide range of capacitor bodies. This termination may be employed on parts where platable terminations are not desired but which will be subjected to soldering conditions.

### PRODUCT BENEFITS

- Phthalate and cadmium and lead free\*
- Good adhesion and solderability
- Dip even large size parts without a blot

\*Phthalate, cadmium and lead “free” as used herein means that phthalate, cadmium and lead are not an intentional ingredients in and are not intentionally added to the referenced product. Trace amounts however may be present.

### PROCESSING

#### Application

Carrier plate-type dipping

#### Substrates

Ceramic capacitors bodies

#### Typical Drying Conditions

160-180°C peak, 15 minute cycle on belt dryer

#### Typical Firing

850°C for 10 minutes at peak, 40 minute cycle

**Table 1-Typical Physical Properties**

Test	Properties
Solids (150°C) [%]	74.5 - 76.5
Viscosity (Pa.s) [Brookfield RVT, 14/6R @ 10 rpm, 25°C]	40 - 60
Thinner	DuPont™ 4553

This table shows anticipated typical physical properties for DuPont™ 4899R based on specific controlled experiments in our labs and are not intended to represent the product specifications, details of which are available upon request.

### Dipping

DuPont™ 4899R termination should be thoroughly mixed before use. This is best achieved by slow, gentle hand stirring with a clean, burr-free spatula (flexible plastic or stainless steel) for 1-2 minutes, or by slow jar rolling for 24 hours. Dipping should be carried out in a clean, well-ventilated area. Note: optimum dipping characteristics of DuPont™ 4899R are generally achieved in the temperature range of 21°C-25°C.

### Firing

Care must be taken to ensure that any gases/vapors from other chemicals or materials (e.g. halogenated solvents) do not enter the furnace muffle. It is also essential that the air supply to the furnace is clean, dry and free of contaminants. Air flows and extraction rates should be optimized to ensure that oxidizing conditions exist within the muffle, and that no furnace exhaust gases enter the room. DuPont™ 4899R termination composition is fired on a 40 minute firing cycle to a peak of 850°C, held for 10 minutes. Variations in the peak firing temperature and/or time at the peak temperature (e.g. 850-900°C for 5-10 minutes at peak can be considered) may result in variations in the final fired properties. Care must be taken to assess the appropriate firing conditions for a particular body type.

### Thinner

DuPont™ 4899R is optimized for dipping and thinning is not normally required. DuPont™ 4553 may be used sparingly for slight adjustments to viscosity or to replace evaporation losses. However, the use of too much thinner or the use of a non-recommended thinner may affect the rheological behavior of the material and its dipping characteristics.



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### STORAGE AND SHELF LIFE

Containers should be stored, tightly sealed, in a clean, stable environment at room temperature (<25°C). Shelf life of material in unopened containers is six months from date of shipment. Some settling of solids may occur and compositions should be thoroughly mixed prior to use.

### SAFETY AND HANDLING

For Safety and Handling information pertaining to this product, read the Material Safety Data Sheet (MSDS).

### FOR MORE INFORMATION ON DUPONT™ 4899R OR OTHER DUPONT MICROCIRCUIT MATERIALS, PLEASE CONTACT YOUR LOCAL REPRESENTATIVE:

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CAUTION: Do not use in medical applications involving permanent implantation in the human body. For other medical applications, see "DuPont Medical Caution Statement," H-50102-5 K-28873 (5/15)